SPIN-VALVE TRANSISTOR 0/538923

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generally relates to the field invention of spintronics, a branch of electronics using the magnetic spin properties of electrons. More particularly, the to the field of invention relates spin-valve transistors which can be used in numerous fields of electronics, either as an individual component (logic gate, non-volatile memory element, etc.), or as a magneto-resistive 10 sensor in numerous fields (automotive, instrumentation, drilling and navigation), read head supporting high-capacity even as а magnetic recording (recording densities greater than a terabit/inch2).

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In a ferromagnetic body, the diffusion of the electrons differs according to their spin. This effect is used in magnetic multilayer devices which are also called spinvalve devices for creating a giant magnetoresistance effect.

Its principle is represented in figures 1a and 1c. A spin valve comprises three successive layers of first layer F1 is layer materials. The a of ferromagnetic metal with imposed magnetization. The 25 is a layer of non-magnetic metal second laver N separating the first layer from the third. The third layer F2 is a layer of ferromagnetic metal with variable magnetization. The operating principle is as 30 follows: if the spin valve is subjected to a magnetic field H, the latter is sufficient to modify the direction of magnetization of the second layer without first The affecting that of the layer. imposed magnetization of the second layer F2 then remains after 35 the magnetic field H has been removed. Depending on the direction of the magnetic field applied, the first and parallel the third layer are then either in a configuration (figure 1a), with both magnetizations pointing in the same direction (black vertical arrows figure 1a), or in anti-parallel configuration (figure 1c), with the two magnetizations pointing in opposite directions (black vertical arrows in figure 1c).

In the parallel configuration, the +1/2 spin electrons e (top oblique arrow in figure 1a) pass through the layers F1 and F2 with a weak diffusion. The resistances $R+_{F1}$ and $R+_{F2}$ of the layers F1 and F2 therefore have a low value r for these electrons. The -1/2 10 electrons e (bottom zig-zag arrow in figure 1A) pass through the layers F1 and F2 with a strong diffusion. The resistances R_{-F1} and R_{-F2} of the layers F1 and F2 therefore have a high value R for these electrons. Finally, the equivalent electrical resistance of the 15 spin valve is represented in the diagram of figure 1b. It is equivalent to two series resistors of valve r placed in parallel with two series resistors of value R. If R is very high compared to r, the equivalent resistance of the circuit is approximately r.

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In the anti-parallel configuration, the +1/2 spin electrons e^- (top arrow in figure 1c) pass through the layer F1 with a weak diffusion (straight-line part of top arrow) and the layer F2 with a strong diffusion 25 (zig-zag part of top arrow). The resistance $R+_{F1}$ of the layer F1 therefore has a low value r for these electrons and the resistance $R+_{F2}$ of the layer F2 has a high value R. The -1/2 spin electrons e (bottom arrow of figure 1c) pass through the layer F1 with a strong 30 diffusion (zig-zag part of bottom arrow) and the layer F2 with a weak diffusion (straight-line part of bottom arrow). The resistance R-F1 of the layer F1 therefore a high value R for these electrons and the resistance $R-_{\rm F2}$ of the layer F2 has a low value r. 35 Finally, the equivalent electrical resistance of the spin valve is represented in the diagram of figure 1d. It is equivalent to two resistors respectively of value r and R placed in parallel with two resistors also of values r and R. If R is very high compared to r, the equivalent 'resistance of the circuit is now approximately R.

The value of the equivalent resistance of the spin valve is thus modified according to the magnetic field applied.

One of the main areas of research in spintronics is in the development of spin-valve transistors. The spin-valve transistors offer major advantages over conventional semiconductor transistors such as, for example, a low switching time, low energies involved and the possibility of programming logic gates.

- 15 Various designs have been proposed since 1995. To illustrate these designs represented in figures 2, 3 and 4, a symbolic notation is used to represent the different layers of the transistor. The symbols used are as follows:
- 20 Layer F1 of ferromagnetic metal with permanent magnetization: rectangle with a single arrow.
 - Layer F2 of ferromagnetic metal with variable magnetization dependent on the magnetic field: rectangle with two arrows head-to-tail.
- 25 Layer N of non-magnetic metal: empty rectangle.
 - Semiconductor layer presenting an electronic Schottky barrier: rectangle topped by a spiked curve, symbolizing the Schottky barrier.
 - Insulating layer I: lozenge with vertical sides.

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The vertical disposition of the different layers is representative of the potential differences applied. Two layers situated at different heights are therefore subject to a potential difference. V_{EB} is used to denote the potential difference existing between the emitter and the base and V_{BC} the potential difference existing between the base and the collector.

In 1995, a' first concept was proposed (D.J. Monsma, J.C. Lodder, T.J.A. Popma and B. Dieny - Perpendicular Hot Electron Spin-Valve Effect in a New Magnetic Field Sensor: The Spin-Valve Transistor - Physical review Letters - Vol. 74, No. 26, 26/06/95). This concept is in figure 2. proposed transistor represented The comprises an emitter E of semiconductor material, metallic base B with three layers F1, N and F2 forming a spin valve and a collector C also of semiconductor material. The emitter/base and base/collector junctions 10 are of Schottky type as indicated in figure 2. The arrow indicates the direction of the collected current. Ιt is opposite to the direction of electron propagation. Electrons are injected from the emitter to 15 the base through the base. Some of these electrons, called hot electrons, have sufficiently high energy to pass through the emitter/base Schottky junction. The energy relaxation of these hot electrons in the metallic base depends on their spin. The collected 20 current I_c strongly depends on the relative orientation of the magnetizations between the layers F1 and F2. The term magneto-current contrast MC is used to describe the following ratio:

 $MC = (I_{C,P} - I_{C,AP}) / (I_{C,P} + I_{C,AP})$

- with $I_{C,P}$ being the maximum current transmitted when the magnetizations are in parallel configuration and $I_{C,AP}$ the minimum current transmitted when the magnetizations are in anti-parallel configuration.
- 30 Strong collector current I_{C} contrasts have been observed with such a device (P.S.A. Kumar et al., Physica C350, 166 (2001)).

However, the relaxation effects of the electrons in the base are significant, the latter comprising a number of successive interfaces, and, on the other hand, the energy of the electrons depends on the potential barrier level difference between the two emitter/base and base/collector Schottky junctions. Now, it is

technologically very difficult to produce significant Schottky junction level differences (greater than 1 eV). Thus, this device can generate only very low-level collector currents, of around 10 nA.

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In 2001, a second spin-valve transistor concept was proposed (S.van Dijken, Xin Jiang, and S.S.P. Parkin room temperature operation of a high output current magnetic tunnel transistor - Applied Physics Letters -10 Vol. 80, No. 18 - 6 May 2002). This so-called MTT (for Magnetic Tunnel Transistor) transistor is represented in Figure 3. It comprises an emitter consisting of a ferromagnetic layer F1 with permanent magnetization, an insulator I, a base B consisting of a ferromagnetic 15 layer F2 with variable magnetization and a collector C of semiconductor material. The base/collector junction is of Schottky type as is indicated in figure 3. The potential differences V_{EB} and V_{BC} required between the base and the emitter and the base and the collector are The spin-polarized electrons are 20 also represented. emitted from the ferromagnetic emitter E by tunnel effect in the ferromagnetic base B. The MTT can be used to limit the relaxation effects of the electrons in the base which is now formed by only a single layer. Higher-level currents I_{C} at the output of the collector 25 obtained. However, the then magnetic junction configuration leads to lower contrasts I_{C} between parallel and anti-parallel current magnetization configurations (less than 70%). 30 results from the fact that this device does not exploit the spin-dependency of the characteristic relaxation length of the hot electrons.

Finally, in 2002, a variant of the MTT was proposed (S.S.P. Parkin - Intermag Europe Conference - Amsterdam - May 2002). This is represented in figure 4. It comprises an emitter E of semiconductor material, an insulator I, a base B which is a spin valve comprising three metallic layers F1, N and F2 and a collector of

semiconductor material. The base/collector junction is of Schottky type. The emitter emits, by tunnel effect, non-spin-polarized electrons towards the spin-valve structure of the base B. Very high collector current contrasts (greater than 3000%) have been observed with this structure. However, the voltage V_{EB} that can be applied between the emitter and the base is limited by the breakdown phenomenon in the tunnel barrier and consequently limits the intensity of the emitter current I_E . The level of the collector current I_C which is proportional to the level of the emitter current I_E also remains limited.

The object of the invention is to provide a new spin-valve transistor arrangement with which to produce both a high-level and high-contrast collector current I_{c} , which is desirable for sensor type applications (weak field detectors or read heads) or as non-volatile memory element or even as programmable logic gate.

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More specifically, the subject of the invention is a spin-valve transistor comprising an emitter, a base and a collector, the emitter being made of a semiconductor material, the base comprising three successive metal layers, the first layer and the third layer being ferromagnetic, the second layer not ferromagnetic, the interface between the emitter and the layers of the base forming a Schottky diode, characterized in that the collector is metallic and separated from the base by a thin insulating layer of approximately a few nanometers, said layer forming a tunnel-effect barrier between the base and said collector.

35 Advantageously, the insulating layer presents a lowerlevel potential barrier than the potential barrier of the Schottky diode existing between the emitter and the base. Advantageously, said insulating layer is made of tantalum oxide or of zinc sulfide or of zirconium oxide or of a rare earth oxide such as yttrium oxide.

5 Advantageously, the insulating layer has a thickness of approximately between 1 and 4 nanometers.

Advantageously, the emitter comprises at least one layer of semiconductor material and the collector at 10 least a first layer of metallic material, the layer of semiconductor material of the emitter comprises at second layer of metallic material least for electrical connection connecting means. These electrical connection means are implanted on the level 15 of the first layer of metallic material, on the level of the second layer of metallic material and of any one of the layers of the base, said connection means being used to apply external voltages and currents to the transistor.

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Finally, the electrical voltage applied between the emitter and the base via the connection means is advantageously greater than the potential barrier of the insulating layer.

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The invention will be better understood, and other advantages will become apparent, from reading the description which follows, given as a nonlimiting example and with reference to the appended figures in which:

- Figures 1a, 1b, 1c and 1d represent schematic diagrams of a spin valve and equivalent circuit diagrams in the parallel and anti-parallel states.
- Figure 2 represents the symbolic diagram of a first embodiment of a spin-valve transistor according to the prior art.
 - Figure 3 represents the symbolic diagram of an MTTtype spin-valve transistor according to the prior art according to a first variant.

- Figure 4 represents the symbolic diagram of an MTTtype spin-valve transistor according to the prior art according to a second variant.
- Figure 5 represents the symbolic diagram of a spinvalve transistor according to the invention.
- Figure 6 represents the arrangement of the various layers of said transistor and the associated electrical connections of the transistor according to the invention.

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Figure 5 represents a symbolic diagram of the spinvalve transistor according to the invention. comprises an emitter E of semiconductor material, a metallic base B made up of three layers F1, N and F2 15 forming a spin valve, an insulating material I and a collector C of electrically conductive material. The emitter/base junction is of Schottky type as indicated in figure 5. The arrow indicates the direction of the collected current. Electrons are injected from the 20 emitter to the base through the emitter/base Schottky junction. The electrons pass from the base B to the collector C through the insulator I either by tunnel effect or ballistically. This arrangement has two major advantages over the prior arrangements. The use of a 25 Schottky type emitter/base junction allows emitter/base voltages V_{EB} to be used, no longer limited by the breakdown phenomenon. It is thus possible to obtain high emitter currents I_E and, consequently, high collector currents Ic. Since the base is formed by a 30 spin valve, the MC contrast of the collector current can also assume high values.

To optimize the device, the materials must be chosen to obtain both a high-level Schottky barrier and a low-level tunnel barrier, lower than the Schottky barrier level. The insulator can in particular be made of tantalum oxide or zinc sulfide or of zirconium oxide or of a rare earth oxide such as yttrium oxide. The material of the emitter is conventionally a

semiconductor material such as silicon or gallium arsenide. The material layers forming the base are, in particular, cobalt or a cobalt alloy for the ferromagnetic layer F1, copper or gold for the neutral layer N, a nickel and iron alloy such as permalloy (with 80% nickel) for the ferromagnetic layer F2, and finally the conductive layer can be of copper or gold.

The collector current I_c is the sum of two currents: 10 Itunnel, tunnel current between base and collector, and Iballistic, ballistic current from the emitter made up of the electrons having sufficient energy to pass through the Schottky junction and then the base relaxing. Since the tunnel current serves no purpose in 15 operation of the transistor, it should minimized. In conventional electronics, it corresponds to a leakage current. The simplest means is to thicken the insulator I used as a tunnel barrier between the base and the collector, the tunnel current decreasing 20 exponentially with this thickness.

It is also advantageous to use an emitter/base voltage V_{EB} greater than the level of the tunnel barrier. In this case, a significant portion of the electrons can pass over the tunnel barrier to reach the collector ballistically. Thus, the level of the collector current is increased.

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Technologically, the spintronic transistor according to 30 the invention is presented as a stack of layers as represented in figure 6. This stack can be produced by deposition methods used in conventional microelectronics. Ιt comprises, successively, metallic layer A, the semiconductor layer of the 35 emitter E, the three metallic layers F1, N and F2 forming the base, the layer of insulating material I the metallic layer C of the collector. electrical connection of the emitter, the base and the collector are provided by connection means C_E , C_B and C_C

which can, for example, be metallic terminals. These connection means C_E , C_B and C_C are located on the level of the metallic layer A located under the emitter E, on the level of the base and on the layer C of the collector. The connection can be made at the level of the base on any one of the three layers F1, N or F2. Figure 6 also shows an electrical polarization diagram of the transistor. A current generator linked to the transistor by the connection means C_E and C_B imposes a current I_E on the input of the emitter and a voltage V_{EB} between the emitter and the base. A voltage generator linked to the transistor by the connection means $C_{\text{\tiny C}}$ and C_B imposes a voltage V_{BC} between the base and the collector. The current collected by the collector depends on the configuration of the magnetizations imposed on the ferromagnetic layers of the base.

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